Metal-Insulator Transition in Two Dimensions: Effects of Disorder and Magnetic Field

Dragana Popović, A. B. Fowler, and S. Washburn³

¹Department of Physics, City College of the City University of New York, New York, New York 10031 and National High Magnetic Field Laboratory, Florida State University, Tallahassee, Florida 32306

²IBM Research Division, T. J. Watson Research Center, Yorktown Heights, New York 10598

³Department of Physics and Astronomy, The University of North Carolina at Chapel Hill, Chapel Hill, North Carolina 27599 (Received 25 April 1997)

The behavior indicative of a metal-insulator transition in a two-dimensional electron system in silicon has been studied. By applying substrate bias, we have reduced the disorder and increased the mobility of our samples and observed the emergence of the metallic behavior when the mobility was high enough in the regime of electron densities where Coulomb interaction energy is much larger than the Fermi energy. In a perpendicular magnetic field, the magnetoconductance is positive in the vicinity of the transition but negative elsewhere. Our experiment suggests that such behavior results from a decrease of the spin-dependent part of the interaction in the vicinity of the transition. [S0031-9007(97)03791-5]

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Since the development of the scaling theory of localization for noninteracting electrons [1], it has been widely believed that there is no metal-insulator transition (MIT) in two dimensions, in agreement with early experiments [2] on a two-dimensional electron system (2DES) in low-mobility $(0.2-0.65 \text{ m}^2/\text{V s})$ Si metaloxide-semiconductor field-effect transistors (MOSFETs). However, recent experiments [3] on high-mobility (2-7 m²/V s) MOSFETs have provided clear evidence for the existence of a MIT in this 2D system, raising speculation that this transition is driven by electron-electron interactions. In an entirely different experiment [4] on mesoscopic Si MOSFETs of comparable quality (peak mobility $\sim 2 \text{ m}^2/\text{V s}$), nonmonotonic behavior of several characteristic energy scales was found in the transition region, in clear contradiction with general considerations based on noninteracting models [1]. The apparent conflict between these experiments and the scaling theory of localization has been resolved recently by formulating a scaling theory for interacting electrons [5], which shows that the existence of a 2D MIT does not contradict any general scaling idea. However, it has not been shown experimentally how the results of Ref. [3] can be reconciled with those obtained on low-mobility samples [2]. It is exactly this issue that our current work resolves.

We present the results obtained on a 2DES in Si MOSFETs with a peak mobility of $0.5-0.8 \,\mathrm{m}^2/\mathrm{V}\,\mathrm{s}$ at 4.2 K. The peak mobility is a rough measure of the amount of disorder, determined primarily by the oxide charge scattering and scattering due to the roughness of the Si-SiO₂ interface [6]. In these samples, all electronic states are localized, in agreement with early studies [2]. By applying the substrate bias, however, we have been able to decrease the disorder scattering and increase the mobility at all carrier densities, with the peak mobility going up to $\approx 1 \,\mathrm{m}^2/\mathrm{V}\,\mathrm{s}$. At that point, the mobility

becomes sufficiently high at carrier densities low enough to allow the Coulomb interaction energy U to be much greater than the Fermi energy E_F [3,5] (in our samples, $U \approx 150 \text{ K} \gg E_F \approx 12 \text{ K}$), and we observe the metalinsulator transition. As shown below, the resulting scaling behavior of the conductivity with temperature T is in excellent agreement with the results of Ref. [3]. In addition, our magnetoconductance measurements in a weak perpendicular field show that the spin-dependent part of the electron-electron interaction decreases sharply at the transition.

Our measurements were carried out on n-channel MOS-FETs fabricated on the (100) surface of Si doped at $\approx 8.3 \times 10^{14}$ acceptors/cm³ with 435 Å gate oxide thickness and oxide charge $\approx 3 \times 10^{10}$ cm $^{-2}$. The samples had a Corbino (circular) geometry with the channel length L=0.4 mm and width W=8 mm. Conductance G was measured as a function of gate voltage V_g (proportional to carrier density n_s) at temperatures 1.2 < T < 4.2 K, using a lock-in at a frequency of ~ 100 Hz and an excitation voltage of 0.3 mV.

Figure 1(a) shows the conductivity $\sigma = GL/W$ for one of the samples (sample 5) as a function of n_s for several temperatures and with no substrate bias $V_{\rm sub}$ applied. As T is lowered, σ decreases for both low and high n_s , indicating insulating behavior. The temperature dependence is weaker at intermediate values of n_s .

Application of a substrate bias in Si MOSFETs at a given n_s changes the electric field at the Si-SiO₂ interface. As a result, the average position of the 2D electrons with respect to the interface is changed as well as the splitting between the subbands [6]. (At low temperatures, all electrons populate only the lowest subband and, therefore, are confined to motion only in the plane parallel to the Si-SiO₂ interface.) The reverse $V_{\rm sub}$ moves the electrons closer to the interface. In some samples, especially those

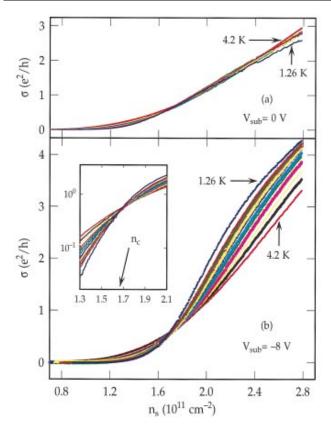


FIG. 1(color). Conductivity σ of sample 5 as a function of n_s for $T=4.2,\ 3.6,\ 3.2,\ 2.8,\ 2.5,\ 2.3,\ 2.08,\ 1.93,\ 1.79,\ 1.67,\ 1.57,\ 1.26$ K and (a) $V_{\rm sub}=0$ V, (b) $V_{\rm sub}=-8$ V. In (a), σ decreases for all n_s as T is lowered. In (b), σ increases as T goes down for all $n_s>n_c$. The inset shows the same data around n_c with σ on a logarithmic scale.

with lightly doped substrates such as ours, where the subband splitting is comparatively small, the mobility $\mu = \sigma/n_s e$ is enhanced [7]. This has been attributed to the reduction of scattering of the 2DES by electrons that occupy very long band tails associated with upper subbands and act as additional scattering centers. The reverse $V_{\rm sub}$ increases the subband splitting and makes this scattering mechanism less important. It may also reduce the average effective mass since the upper subband electrons are heavier. In addition, the reverse $V_{\rm sub}$ reduces the average spatial extent Δz of the inversion layer charge density in the direction perpendicular to the interface (typically, $\Delta z \approx 20{\text -}30 \text{ Å [6]}$).

We find, for example, that $V_{\rm sub} = -1$ V leads to a slight increase of μ and the merging of different temperature curves over a wide range of n_s , roughly between 1.8 and 2.4×10^{11} cm⁻². At the highest n_s , the temperature dependence of σ still indicates insulating behavior. The reason for the merging at intermediate values of n_s becomes clear upon the application of an even higher (reverse) $V_{\rm sub}$, as shown in Fig. 1(b) for $V_{\rm sub} = -8$ V: the temperature dependent behavior of σ is now reversed for all n_s above some critical electron

density n_c [$n_c = (1.67 \pm 0.02) \times 10^{11}$ cm⁻² for sample 5], as expected for metallic behavior. For $n_s < n_c$, the 2DES exhibits insulating behavior as before. We have obtained similar results on another sample (sample 1), where $V_{\rm sub} = -9$ V was used to raise the peak mobility to 1 m²/V s and study the metal-insulator transition at $n_c = (1.65 \pm 0.02) \times 10^{11}$ cm⁻².

The results displayed in Fig. 1(b) are very similar to those reported in Ref. [3], where it was also found that the resistivity $\rho = 1/\sigma$ scales with temperature near the transition according to

$$\rho(T, n_s) = f(|\delta_n|/T^{1/z\nu}) = \rho(T/T_0),$$
 (1)

with a single parameter T_0 that is the same function of $\delta_n \equiv (n_s - n_c)/n_c$ on both the metallic and the insulating side of the transition, $T_0 \propto |\delta_n|^{z\nu}$. Here z is the dynamical exponent and ν is the correlation length exponent. The results of this scaling for the data in Fig. 1(b) are shown in Fig. 2. All the data collapse onto two branches: the upper one for the metallic side of the transition and the lower one for the insulating side. The best collapse is found for $z\nu = 1.6 \pm 0.1$, where quite a wide range of electron densities (with $|\delta_n|$ up to 0.25) was used. For sample 1, we find that $z\nu = 1.5 \pm 0.1$. These results are in remarkable agreement with experiments on high-mobility MOSFETs [3]. We find that the critical conductivity $\sigma_c=0.5e^2/h=e^2/2h$ for sample 5 and $\sigma_c=0.65e^2/h\approx e^2/1.5h$ for sample 1 consistent with the reported [3] values and suggesting that the critical conductivity in Si MOSFETs has a value around $e^2/2h$.

The scaling theory predicts [5] that, to leading order, the temperature dependence of the conductivity in the critical region associated with the metal-insulator transition will be given by

$$\sigma(\delta_n, T) = \sigma_c \exp(A\delta_n/T^{1/z\nu}), \qquad (2)$$

where A is an unknown constant. In other words, the temperature dependence of σ is predicted to be exponential

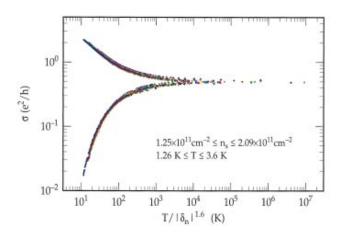


FIG. 2(color). Scaling of conductivity with temperature for sample 5, using the data shown in Fig. 1(b) in the n_s and T ranges given on the plot.

on *both* insulating and metallic sides of the transition, and with the same exponent. This symmetry is expected to hold only for $T > T_0(\delta_n)$, i.e., the quantum critical region is defined by the temperature scale T_0 . The data presented in Fig. 2 are shown again in Fig. 3 as a function of $|\delta_n|/T^{1/z\nu}$, with $z\nu=1.6$. They are consistent with the theory, and we observe the symmetry for $|\delta_n|/T^{1/1.6}$ of up to 0.045. This value defines $T_0(|\delta_n|)$, and we find that $T_0=143|\delta_n|^{1.6}$. For the range of temperatures of up to 3.6 K, for which scaling works; this means that the quantum critical region extends at most up to $|\delta_n|=0.1$.

We have performed careful magnetoconductance measurements in perpendicular magnetic fields B of up to 1 T. Figure 4(a) shows magnetoconductance (MC), defined as $\Delta \sigma / \sigma(0) = [\sigma(B) - \sigma(0)] / \sigma(0)$, for sample 1 with $V_{\rm sub} = -9$ V, for several carrier densities in the critical region. As the (zero-field) critical density n_c is approached from the metallic side, the positive MC develops gradually, reaches a maximum at $B \sim 0.5$ T when $n_s = n_c$, and then disappears gradually on the insulating side. Exactly the same behavior is found in high-mobility mesoscopic Si MOSFETs [8] at much lower temperatures, down to 40 mK. At higher B, and for n_s outside this narrow critical region, MC is always negative. The dependence of MC on n_s is displayed clearly in Fig. 4(b) for several magnetic fields. MC exhibits a pronounced maximum at $n_s = n_c$.

Obviously, there are positive and negative contributions to the measured MC. It is well established that the positive MC can result from quantum interference effects in both weakly [9] and strongly [10,11] disordered systems. The spin-dependent part of the electron-electron interaction [9] gives rise to negative MC, at least in the weakly disordered regime. This has been well established in doped semiconductors [12], and large negative MC has been seen in high-mobility MOSFETs for *B* paral-

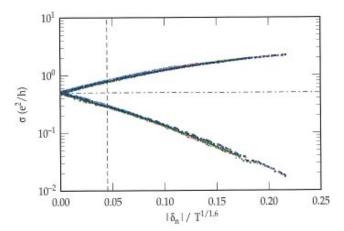


FIG. 3(color). Temperature dependence of σ for sample 5, using the data shown in Fig. 2. Vertical and horizontal dashed lines are visual aids: The horizontal line shows the value of σ_c and the vertical line shows the upper limit of the range of $|\delta_n|/T^{1/1.6}$ within which the symmetry is observed.

lel to the current plane [13]. In all cases, one expects $|\Delta \sigma / \sigma(0)| \propto B^2$ in the low-field limits, becoming weaker for B higher than some characteristic field. In case of weak localization, the characteristic field is reached when the Landau orbit size becomes comparable to the thermal length, i.e., when $2eB_0/\hbar \sim kT/\hbar D$, where D is the diffusion constant [9], so that $B_0 \sim 0.3$ T for our samples. In our experiment, MC changes sign and becomes negative at sufficiently high B for all n_s in the critical region $(|\delta_n| \le 0.1)$. We, therefore, conclude that the positive contribution is no longer in the low-field limit, consistent with the estimate of $B_0 \sim 0.3$ T. On the other hand, there is a negative, predominantly quadratic B dependence at the highest fields, indicating that the negative contribution to the MC is still in the low-field regime. This is consistent with the estimated characteristic field for the MC due to spin splitting in an interacting electron gas, given by the condition that the Zeeman energy is comparable to the thermal energy, i.e., $g \mu_B B \sim kT$ [9], and, for $g \sim 2$ [14], $g\mu_B B \sim 1.4 \text{ K at } B = 1 \text{ T}.$

In order to understand the puzzling n_s dependence of MC [Fig. 4(b)], it is desirable to disentangle the two contributions. Obviously, the MC in our samples can be described by

$$\Delta \sigma / \sigma(0) = \alpha f(B) - \beta B^2, \tag{3}$$

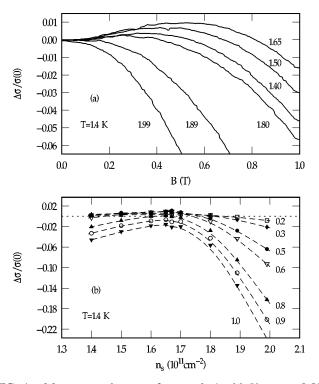


FIG. 4. Magnetoconductance for sample 1 with $V_{\rm sub} = -9$ V and $n_c = 1.65 \times 10^{11}$ cm⁻². (a) The carrier densities corresponding to different curves are shown on the plot in units of 10^{11} cm⁻². (b) The magnetic fields corresponding to different symbols are shown on the plot in units of tesla. Dashed lines are guides to the eye.

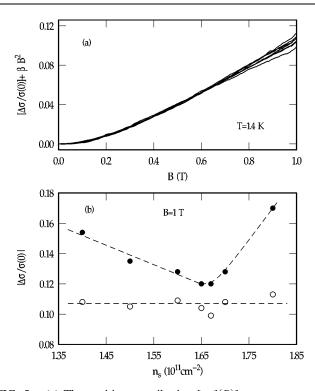


FIG. 5. (a) The positive contribution $[\alpha f(B)]$ to magnetoconductance for all $1.40 \le n_s (10^{11} \text{ cm}^{-2}) \le 1.80$. (b) Magnetoconductance vs n_s for B=1 T. Open symbols represent the positive contribution and solid symbols represent the negative one. Dashed lines are guides to the eye.

with $\alpha, \beta > 0$. We find that, for B > 0.3 T, $[\Delta \sigma / \sigma(0)]/B^2$ has the same form, up to a constant (β) , for all n_s . Figure 5(a) shows that different $\alpha f(B)$ curves are indeed indistinguishable to within the scatter of data and, therefore, independent of n_s . In this way, we have been able to determine the change in β as n_s is varied, independent of the choice of f(B). In order to obtain the absolute values of β in Fig. 5, we have used $f(B) = B^{3/2}$ [15]. Figure 5(b) presents both the positive $[\alpha f(B)$: open symbols] and the negative contribution $[\beta B^2]$: solid symbols as a function of n_s for B = 1 T. The positive MC due to quantum interference does not depend on n_s within the scatter of data. On the other hand, the negative contribution, i.e., $\beta(n_s)$, has a strong minimum at the metal-insulator transition.

In summary, we have shown that the metallic behavior can be observed in a 2DES by increasing its mobility, consistent with the assertion [3,5] that the 2D MIT is driven by electron-electron interactions. We have also shown that the negative part of the MC, determined by the spin-dependent part of the interaction, decreases sharply at the transition. We point out striking similarities between transport properties of a 2DES in Si MOSFETs and those observed in Si:B, which is a 3D system: (a) The T dependence is qualitatively the same, i.e., σ increases with de-

creasing *T* in the metallic phase [16], and (b) magnetoconductance, which is negative in Si:B, depends strongly on the carrier concentration and shows a dramatic decrease at the transition [17]. We recall that such anomalous behavior has been attributed to the interplay of electron-electron interactions and disorder in the case of Si:B. Our experiment suggests the possibility that electron-electron interactions may play a similar role in both 2D and 3D systems near the metal-insulator transition.

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